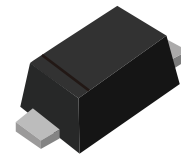


FEATURES

- Small Package
- Low Reverse Current
- Fast Switching Speed
- Flat Lead Surface Mount Device



SOD-523

MECHANICAL DATA

- SOD-523 Small Outline Plastic Package
- Polarity: Color band denotes cathode end
- Mounting Position: Any

APPROVALS

RoHS	Compliance with 2011/65/EU
HF	Compliance with IEC61249-2-21:2003

MAXIMUM RATINGS ($T_A=25^{\circ}\text{C}$)

Parameter	Symbol	Value	Unit
Reverse Voltage	V_R	75	V
Peak Reverse Voltage	V_{RM}	100	V
Power Dissipation	P_d	150	mW
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	833	$^{\circ}\text{C}/\text{W}$
Average Rectified Current	I_o	250	mA
Non-repetitive Peak Forward Current	I_{FM}	500	mA
Peak Forward Surge Current @ $t_p=1\mu\text{s}$; $T_A=25^{\circ}\text{C}$	I_{FSM}	2.0	A
Operating junction temperature range	T_J	150	$^{\circ}\text{C}$
Storage temperature range	T_{STG}	-55 to 150	$^{\circ}\text{C}$

ELECTRICAL CHARACTERISTICS($T_A=25^{\circ}\text{C}$)

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Breakdown Voltage	B_V	$I_R=100\mu\text{A}$	100			V
		$I_R=5\mu\text{A}$	75			nA
Reverse Leakage Current	I_R	$V_R=20\text{V}$			25	μA
		$V_R=75\text{V}$			1	μA
Forward Voltage	V_F	$I_F=5\text{mA}$			0.715	V
		$I_F=10\text{mA}$			0.855	V
		$I_F=100\text{mA}$			1.00	V
		$I_F=150\text{mA}$			1.25	V
Capacitance	C_J	$V_R=0\text{V}$, $f=1\text{MHz}$			4	pF
Reverse Recovery Time	t_{rr}	$I_F=I_R=10\text{mA}$, $R_L=100\Omega$, $I_{RR}=0.1\times I_R$			4	nS

CHARACTERISTIC CURVES

Fig.1 Forward Characteristics

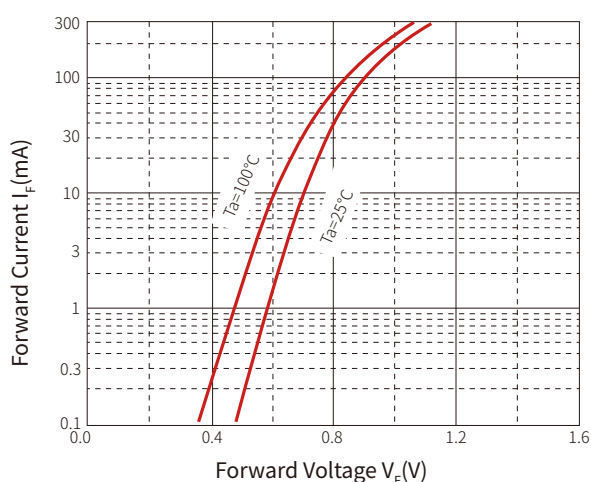


Fig.2 Reverse Characteristics

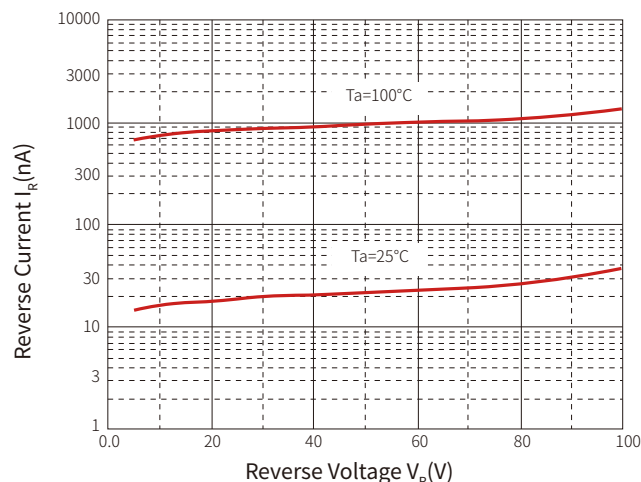
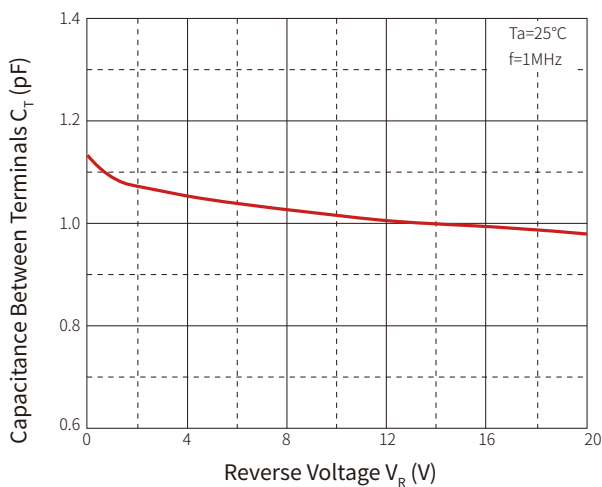
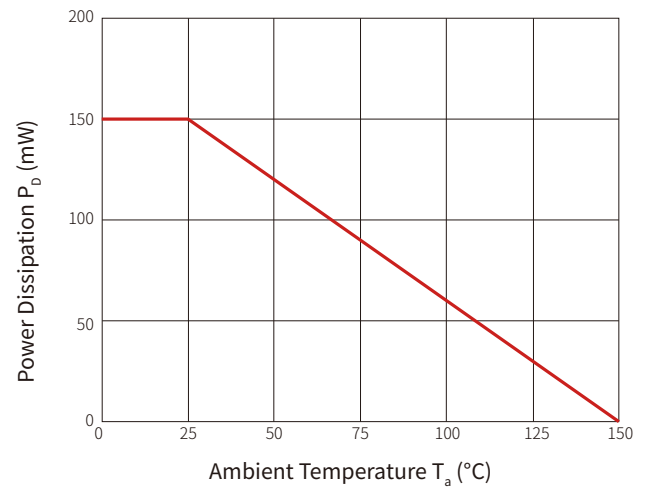
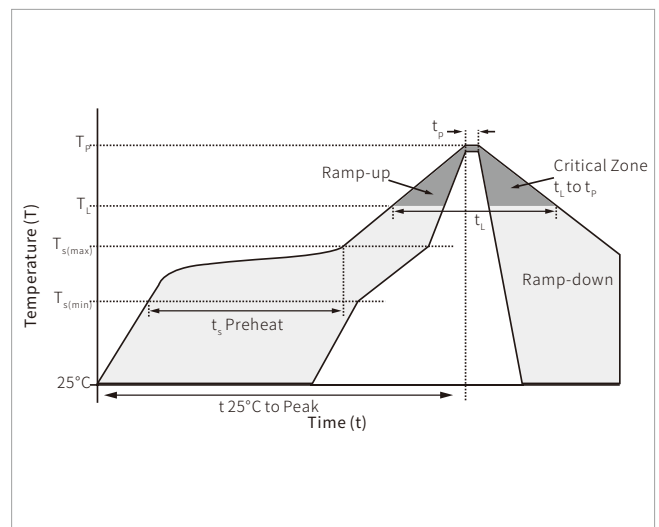


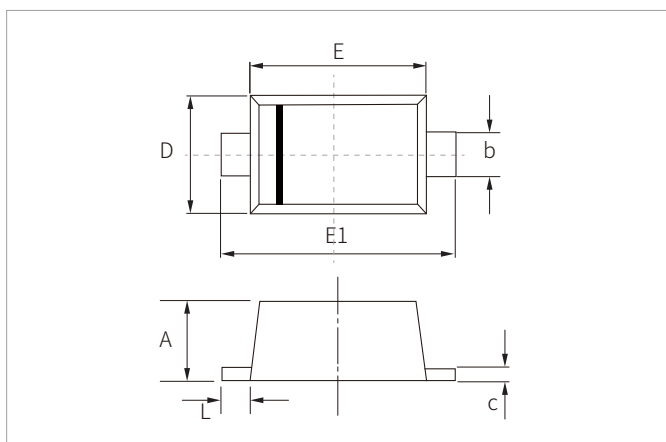
Fig.3 Capacitance Characteristics

Fig.4 Power Derating Curve


SOLDERING PARAMETERS

Reflow Condition		Lead-free assembly
Pre Heat	Temperature Max ($T_{s(\min)}$)	150 $^\circ\text{C}$
	Temperature Max ($T_{s(\max)}$)	200 $^\circ\text{C}$
	Time (min to max) (t_s)	60 – 180 secs
Average ramp up rate (Liquidus Temp (T_L) to peak)		3 $^\circ\text{C}/\text{second}$ max
$T_{s(\max)}$ to T_L - Ramp-up Rate		3 $^\circ\text{C}/\text{second}$ max
Reflow	Temperature (T_L) (Liquidus)	217 $^\circ\text{C}$
	Time (min to max) (t_L)	60 – 150 seconds
Peak Temperature (T_p)		260 $^\circ\text{C}$
Time within 5 $^\circ\text{C}$ of actual peak Temperature (t_p)		20 – 40 seconds
Ramp-down Rate		6 $^\circ\text{C}/\text{second}$ max
Time 25 $^\circ\text{C}$ to peak Temperature (T_p)		8 minutes max.
Do not exceed		260 $^\circ\text{C}$

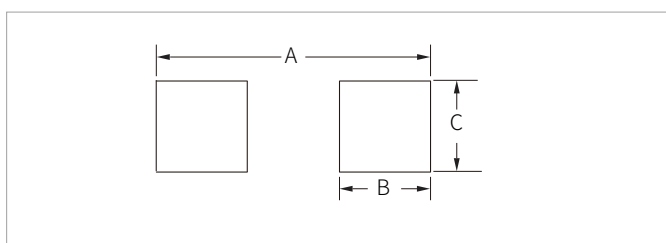


SOD-523 PACKAGE INFORMATION



Ref.	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	0.50	0.80	0.020	0.031
b	0.25	0.35	0.010	0.014
c	0.07	0.20	0.003	0.008
D	0.70	0.90	0.028	0.035
E	1.10	1.30	0.043	0.051
E1	1.50	1.70	0.059	0.067
L	0.15	0.25	0.006	0.010

RECOMMENDED PAD LAYOUT DIMENSIONS



Ref.	Millimeters	Inches
	Min.	Min.
A	2.00	0.0787
B	0.60	0.0236
C	0.70	0.0276

ORDERING INFORMATION

Part Number	Marking	Component Package	QTY/Reel	Reel Size
1N4448WT	T5	SOD-523	3000PCS	7"

Headquarters

No.3387 Shendu Road
Pujiang I&E Park
Minhang Shanghai China
201000

Hotline

400-021-5756

Web

<https://www.semiware.com>

Sales Center

Tel: 86-21-3463-7458
Email: sales18@semiware.com

Customer Service

Tel: 86-21-5484-1001
Email: sales17@semiware.com

Technical Support

Tel: 86-21-3463-7654
Email: fae01@semiware.com

Complaint & Suggestions

Tel: 86-21-3463-7172
Ext: 8868
Email: cs03@semiware.com

By QR Code

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